

LNPTTM THERMOCOMPTM COMPOUND GF003

GF-1003

DESCRIPTION

LNP THERMOCOMP GF003 compound is based on Polysulfone (PSU) resin containing 15% glass fiber.

GENERAL INFORMATION

Features	High stiffness/Strength, High temperature resistance, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polysulfone (PSU)
Processing Techniques	Injection Molding

INDUSTRY

Building and Construction
Consumer
Electrical and Electronics
Industrial

SUB INDUSTRY

Building Component
Personal Accessory
Mobile Phone - Computer - Tablets
Electrical

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, brk, Type I, 5 mm/min	86	MPa	ASTM D638
Tensile Strain, yld, Type I, 5 mm/min	2.9	%	ASTM D638
Tensile Strain, brk, Type I, 5 mm/min	3.1	%	ASTM D638
Tensile Modulus, 50 mm/min	5490	MPa	ASTM D638
Flexural Stress, brk, 1.3 mm/min, 50 mm span	146	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	4720	MPa	ASTM D790
Tensile Stress, break, 5 mm/min	86	MPa	ISO 527
Tensile Strain, yield, 5 mm/min	2.8	%	ISO 527
Tensile Strain, break, 5 mm/min	3.1	%	ISO 527
Tensile Modulus, 1 mm/min	5420	MPa	ISO 527
Flexural Modulus, 2 mm/min	4710	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, unnotched, 23°C	570	J/m	ASTM D4812
Izod Impact, notched, 23°C	45	J/m	ASTM D256
Multiaxial Impact	3	J	ISO 6603
Instrumented Dart Impact Total Energy, 23°C	14	J	ASTM D3763
Izod Impact, unnotched 80*10*4 +23°C	37	kJ/m ²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	4	kJ/m ²	ISO 180/1A
THERMAL ⁽¹⁾			
HDT, 0.45 MPa, 3.2 mm, unannealed	184	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	179	°C	ASTM D648

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CHEMISTRY THAT MATTERS™

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
CTE, -30°C to 30°C, flow	3.18E-05	1 / °C	ASTM D696
CTE, -30°C to 30°C, xflow	5.5E-05	1 / °C	ASTM D696
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	185	°C	ISO 75 /Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	179	°C	ISO 75 /Af
PHYSICAL ⁽¹⁾			
Specific Gravity	1.36	-	ASTM D792
Density	1.35	g / cm ³	ASTM D792
Moisture Absorption, (23°C/50% RH/ 24 hrs)	0.21	%	ASTM D570
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.4 – 0.6	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.5 – 0.7	%	ASTM D955
Density	1.35	g / cm ³	ISO 1183
Moisture Absorption (23°C / 50% RH)	0.34	%	ISO 62
INJECTION MOLDING ⁽³⁾			
Drying Temperature	120 – 150	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.05	%	
Melt Temperature	360 – 370	°C	
Front - Zone 3 Temperature	350 – 360	°C	
Middle - Zone 2 Temperature	340 – 350	°C	
Rear - Zone 1 Temperature	325 – 340	°C	
Mold Temperature	150	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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